

# DATA SHEET



## **PEMH11**

**NPN resistor-equipped transistors;  
R1 = 10 k $\Omega$ , R2 = 10 k $\Omega$**

Preliminary specification

2001 Oct 22

# NPN resistor-equipped transistors; R1 = 10 kΩ, R2 = 10 kΩ

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### FEATURES

- 300 mW total power dissipation
- Very small 1.6 × 1.2 mm ultra thin package
- Self alignment during soldering due to straight leads
- Replaces two SC-75/SC-89 packaged transistors on same PCB area
- Reduces required PCB area
- Reduced pick and place costs.

### APPLICATIONS

- General purpose switching and amplification
- Inverter and interface circuits
- Circuit driver.

### DESCRIPTION

NPN resistor-equipped transistors in a SOT666 plastic package.

### MARKING

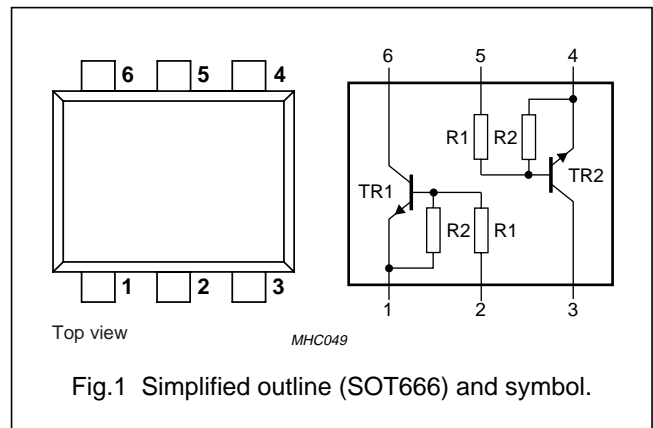
| TYPE NUMBER | MARKING CODE |
|-------------|--------------|
| PEMH11      | H1           |

### QUICK REFERENCE DATA

| SYMBOL           | PARAMETER                 | MAX. | UNIT |
|------------------|---------------------------|------|------|
| V <sub>CEO</sub> | collector-emitter voltage | 50   | V    |
| I <sub>CM</sub>  | peak collector current    | 100  | mA   |
| TR1              | NPN                       | –    | –    |
| TR2              | NPN                       | –    | –    |
| R1               | bias resistor             | 10   | kΩ   |
| R2               | bias resistor             | 10   | kΩ   |

### PINNING

| PIN  | DESCRIPTION        |
|------|--------------------|
| 1, 4 | emitter TR1; TR2   |
| 2, 5 | base TR1; TR2      |
| 6, 3 | collector TR1; TR2 |



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**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL                | PARAMETER                             | CONDITIONS                       | MIN. | MAX. | UNIT |
|-----------------------|---------------------------------------|----------------------------------|------|------|------|
| <b>Per transistor</b> |                                       |                                  |      |      |      |
| V <sub>CBO</sub>      | collector-base voltage                | open emitter                     | –    | 50   | V    |
| V <sub>CEO</sub>      | collector-emitter voltage             | open base                        | –    | 50   | V    |
| V <sub>EBO</sub>      | emitter-base voltage                  | open collector                   | –    | 10   | V    |
| V <sub>i</sub>        | input voltage<br>positive<br>negative |                                  | –    | +40  | V    |
|                       |                                       |                                  | –    | –10  | V    |
| I <sub>o</sub>        | output current (DC)                   |                                  | –    | 100  | mA   |
| I <sub>CM</sub>       | peak collector current                |                                  | –    | 100  | mA   |
| P <sub>tot</sub>      | total power dissipation               | T <sub>amb</sub> ≤ 25 °C; note 1 | –    | 200  | mW   |
| T <sub>stg</sub>      | storage temperature                   |                                  | –65  | +150 | °C   |
| T <sub>j</sub>        | junction temperature                  |                                  | –    | 150  | °C   |
| T <sub>amb</sub>      | operating ambient temperature         |                                  | –65  | +150 | °C   |
| <b>Per device</b>     |                                       |                                  |      |      |      |
| P <sub>tot</sub>      | total power dissipation               | T <sub>amb</sub> ≤ 25 °C; note 1 | –    | 300  | mW   |

**Note**

1. Transistor mounted on an FR4 printed-circuit board.

**THERMAL CHARACTERISTICS**

| SYMBOL              | PARAMETER                                   | CONDITIONS    | VALUE | UNIT |
|---------------------|---|---------------|-------|------|
| R <sub>th j-a</sub> | thermal resistance from junction to ambient | notes 1 and 2 | 416   | K/W  |

**Notes**

1. Transistor mounted on an FR4 printed-circuit board.
2. The only recommended soldering method is reflow soldering.

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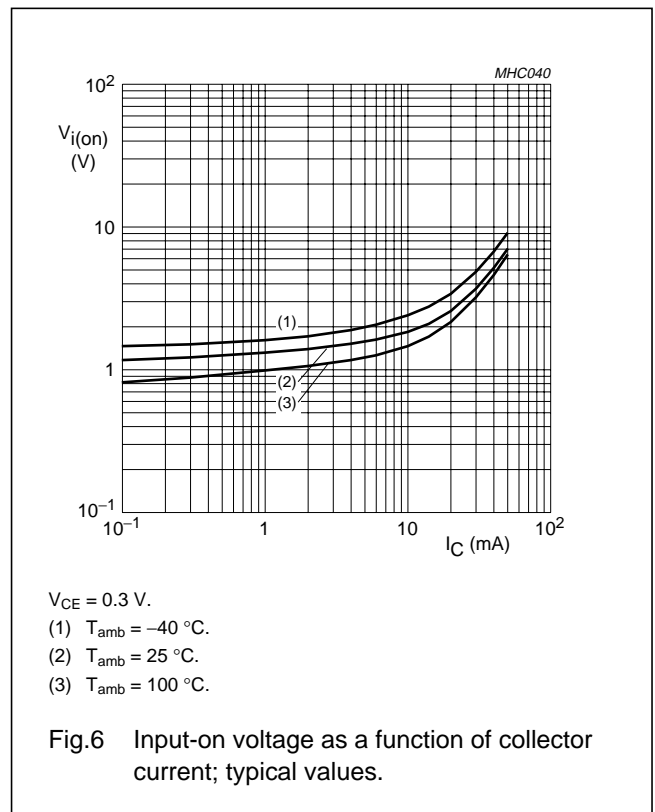
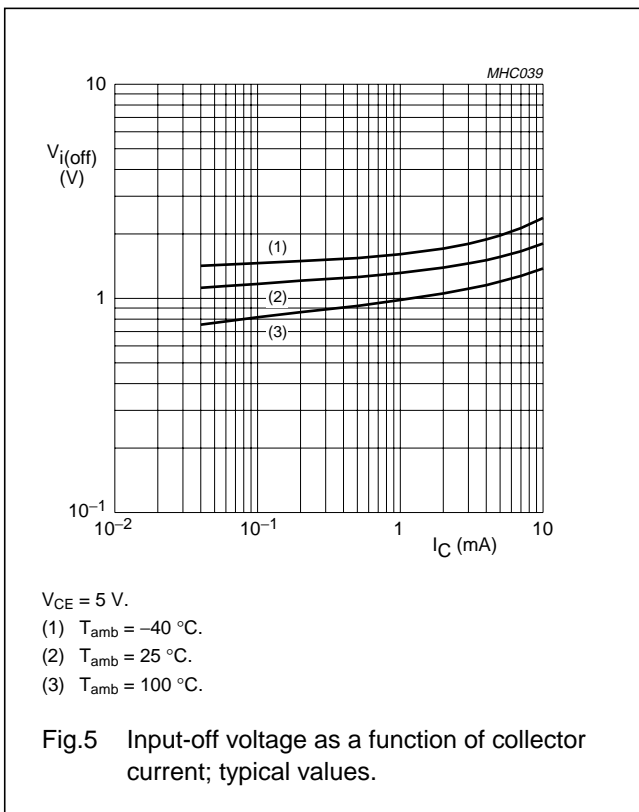
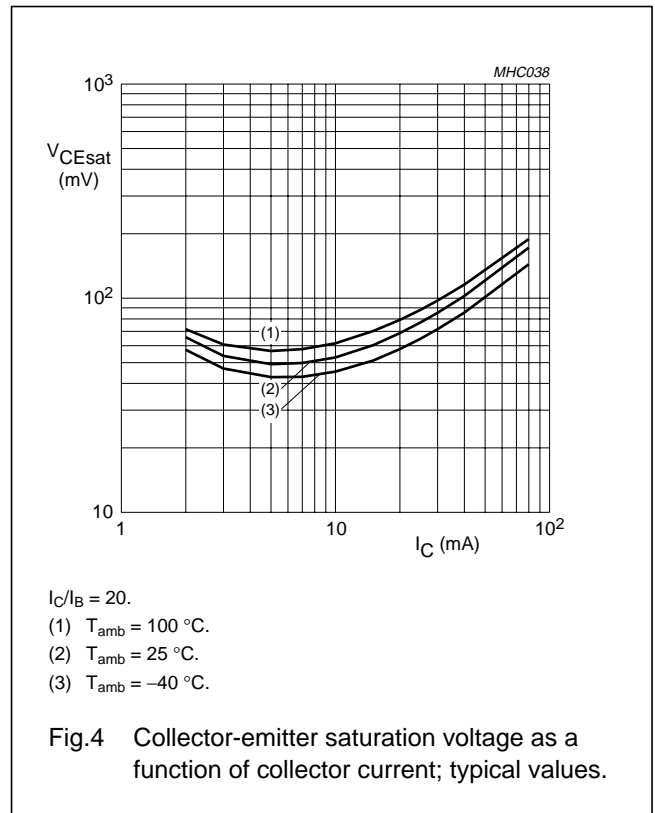
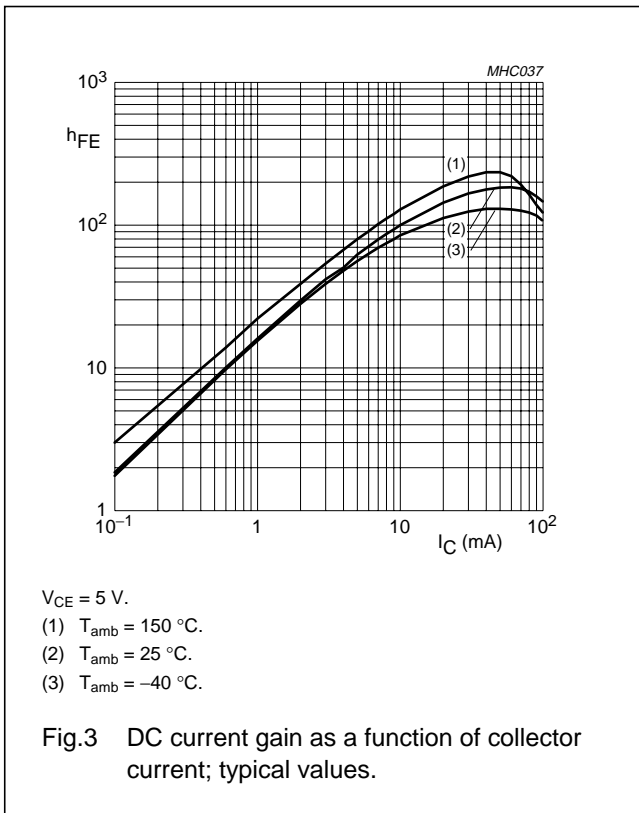
**CHARACTERISTICS**

$T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$ ; unless otherwise specified.

| SYMBOL                | PARAMETER                            | CONDITIONS  | MIN. | TYP. | MAX. | UNIT             |
|-----------------------|--------------------------------------|---|------|------|------|------------------|
| <b>Per transistor</b> |                                      |   |      |      |      |                  |
| $I_{\text{CBO}}$      | collector-base cut-off current       | $V_{\text{CB}} = 50\text{ V}$ ; $I_{\text{E}} = 0$  | –    | –    | 100  | nA               |
| $I_{\text{CEO}}$      | collector-emitter cut-off current    | $V_{\text{CE}} = 50\text{ V}$ ; $I_{\text{B}} = 0$  | –    | –    | 1    | $\mu\text{A}$    |
|                       |                                      | $V_{\text{CE}} = 30\text{ V}$ ; $I_{\text{B}} = 0$ ; $T_{\text{j}} = 150\text{ }^{\circ}\text{C}$ | –    | –    | 50   | $\mu\text{A}$    |
| $I_{\text{EBO}}$      | emitter-base cut-off current         | $V_{\text{EB}} = 5\text{ V}$ ; $I_{\text{C}} = 0$   | –    | –    | 400  | $\mu\text{A}$    |
| $h_{\text{FE}}$       | DC current gain                      | $V_{\text{CE}} = 5\text{ V}$ ; $I_{\text{C}} = 5\text{ mA}$                                       | 30   | –    | –    |                  |
| $V_{\text{CEsat}}$    | collector-emitter saturation voltage | $I_{\text{C}} = 10\text{ mA}$ ; $I_{\text{B}} = 0.5\text{ mA}$                                    | –    | –    | 150  | mV               |
| $V_{\text{i(off)}}$   | input off voltage                    | $V_{\text{CE}} = 5\text{ V}$ ; $I_{\text{C}} = 100\text{ }\mu\text{A}$                            | –    | –    | 0.5  | V                |
| $V_{\text{i(on)}}$    | input on voltage                     | $V_{\text{CE}} = 0.3\text{ V}$ ; $I_{\text{C}} = 10\text{ mA}$                                    | 2.5  | –    | –    | V                |
| R1                    | input resistor                       |   | 7    | 10   | 13   | $\text{k}\Omega$ |
| $\frac{R2}{R1}$       | resistor ratio                       |   | 0.8  | 1    | 1.2  |                  |
| $C_{\text{c}}$        | collector capacitance                | $I_{\text{E}} = i_{\text{e}} = 0$ ; $V_{\text{CB}} = 10\text{ V}$ ; $f = 1\text{ MHz}$            | –    | –    | 2.5  | pF               |

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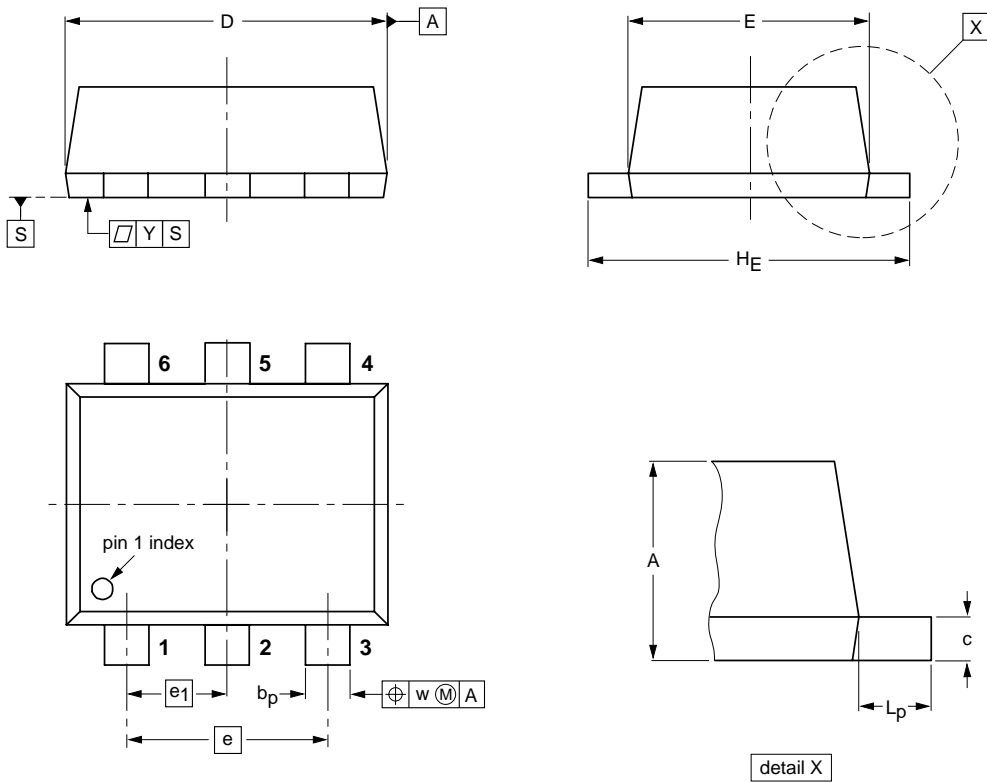
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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT666



DIMENSIONS (mm are the original dimensions)

| UNIT | A          | b <sub>p</sub> | c            | D          | E          | e   | e <sub>1</sub> | H <sub>E</sub> | L <sub>p</sub> | w   | y   |
|------|------------|----------------|--------------|------------|------------|-----|----------------|----------------|----------------|-----|-----|
| mm   | 0.6<br>0.5 | 0.27<br>0.17   | 0.18<br>0.08 | 1.7<br>1.5 | 1.3<br>1.1 | 1.0 | 0.5            | 1.7<br>1.5     | 0.3<br>0.1     | 0.1 | 0.1 |

| OUTLINE VERSION | REFERENCES |       |      |  | EUROPEAN PROJECTION | ISSUE DATE           |
|-----------------|------------|-------|------|--|---------------------|----------------------|
|                 | IEC        | JEDEC | EIAJ |  |                     |                      |
| SOT666          |            |       |      |  |                     | 01-01-04<br>01-08-27 |

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## DATA SHEET STATUS

| DATA SHEET STATUS <sup>(1)</sup> | PRODUCT STATUS <sup>(2)</sup> | DEFINITIONS  |
|----------------------------------|-------------------------------|--|
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